# **IP4369CX4**

# ESD protection for high-speed interfaces Rev. 1 — 1 October 2012

**Product data sheet** 

#### **Product profile** 1.

#### 1.1 General description

The device is designed to protect high-speed interfaces such as High-Definition Multimedia Interface (HDMI), DisplayPort, USB, external Serial Advanced Technology Attachment (eSATA) and Low Voltage Differential Signaling (LVDS) interfaces against ElectroStatic Discharge (ESD).

The device includes high-level ESD protection diodes structure for high-speed signal lines in a 4-channel 0.4 mm pitch single Wafer-Level Chip-Scale Package (WLCSP). These features make the device ideal for use in applications requiring component miniaturization such as mobile phone handsets and other portable electronic devices.

All signal lines are protected by a special diode configuration offering ultra low line capacitance of 0.8 pF (typical). These diodes provide protection to downstream components from ESD voltages up to  $\pm 8$  kV contact according to IEC 61000-4-2, level 4.

#### 1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- System ESD protection for USB 2.0, USB On-The-Go (USB OTG), Ethernet and Digital Visual Interface (DVI)
- All signal lines with integrated rail-to-rail clamping diodes structure for downstream ESD protection of ±8 kV according to IEC 61000-4-2, level 4
- 2 × 2 solder ball WLCSP with 0.4 mm pitch and height < 500 μm</p>
- Signal lines with ≤ 0.05 pF matching capacitance between signal pairs
- Line capacitance of only 0.8 pF for each channel

#### 1.3 Applications

The device is designed for high-speed receiver and transmitter port protection:

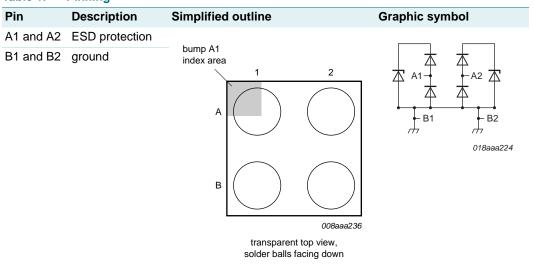
- Portable devices
- Mobile handsets
- Wireless data systems
- Digital cameras



## **ESD** protection for high-speed interfaces

# 2. Pinning information

Table 1. Pinning



# 3. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
IP4369CX4	WLCSP4	wafer level chip-size package; 4 bumps (2 × 2)	IP4369CX4	

# 4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{I}$	input voltage		-0.5	+5.5	V
V <sub>ESD</sub>	electrostatic discharge voltage	IEC 61000-4-2, level 4; contact discharge	<u>[1]</u> _	±8	kV
T <sub>stg</sub>	storage temperature		<b>-55</b>	+150	°C
T <sub>reflow(peak)</sub>	peak reflow temperature	$t_p \le 10 \text{ s}$	-	+260	°C
T <sub>amb</sub>	ambient temperature		-30	+85	°C

<sup>[1]</sup> Pins A1 and A2 to ground (B1 and B2).

## **ESD** protection for high-speed interfaces

# 5. Characteristics

Table 4. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C <sub>line</sub>	line capacitance	per pin; pins A1 and A2 to GDN; $V_{bias} = 0 V$ ; $f = 1 MHz$	[1]	-	8.0	1	pF
C <sub>(I/O-I/O)</sub>	input/output to input/output capacitance	GND not connected; V <sub>bias</sub> = 0 V; f = 1 MHz	[1]	-	0.4	-	pF
I <sub>RM</sub>	reverse leakage current	$V_{\text{bias}} = 3 \text{ V}$		-	-	100	nΑ
$V_{BR}$	breakdown voltage	I <sub>test</sub> = 1 mA		6	-	10	V
$V_{F}$	forward voltage			-	-0.7	-	V
R <sub>dyn</sub> dynamic resistance	TLP	[2]					
	positive transient		-	0.24	-	Ω	
	negative transient		-	0.21	-	Ω	
		surge	[3]				
		positive transient		-	0.21	-	Ω
		negative transient		-	0.16	-	Ω
$V_{CL}$	clamping voltage	I <sub>CL</sub> = 4 A	[3]	-	4	-	V
		I <sub>CL</sub> = −5 A	[3]	-	-3	-	V

<sup>[1]</sup> This parameter is guaranteed by design.

<sup>[3]</sup> According to IEC 61000-4-5 (8/20  $\mu$ s).

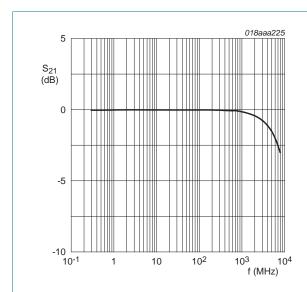


Fig 1. Mixed-mode differential insertion loss; typical values

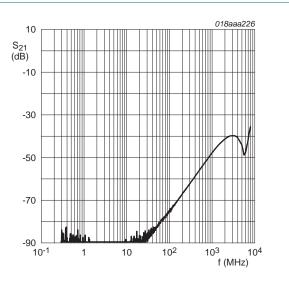
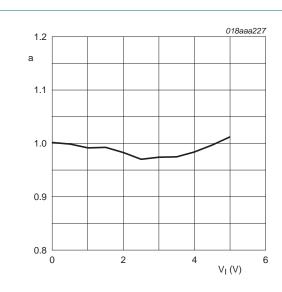


Fig 2. Mixed-mode differential crosstalk, typical values

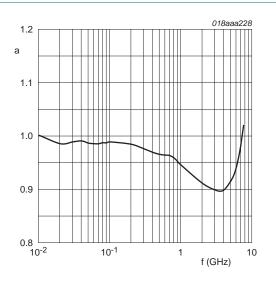
<sup>[2] 100</sup> ns Transmission Line Pulse (TLP); 50  $\Omega$ ; pulser at 80 ns.

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$$a = \frac{C_{line}}{C_{line(V_{bias} = 0V)}}$$

Fig 3. Relative capacitance as a function of input voltage; typical values



$$a = \frac{C_{line}}{C_{line(f = 10MHz)}}$$

Fig 4. Relative capacitance as a function of frequency; typical values

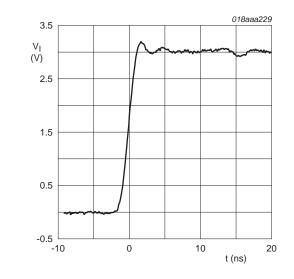


Fig 5. Input voltage for crosstalk measurements; channel 1; typical values

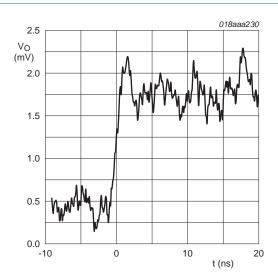
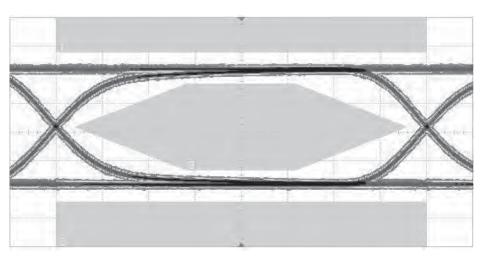


Fig 6. Output voltage for crosstalk measurements; channel 2; typical values

<u>Figure 5</u> and <u>6</u> show time-domain crosstalk from channel 1 to channel 2. Generator impedance on channel 1 is 50  $\Omega$ , probe impedance on channel 2 is 1 M $\Omega$ .

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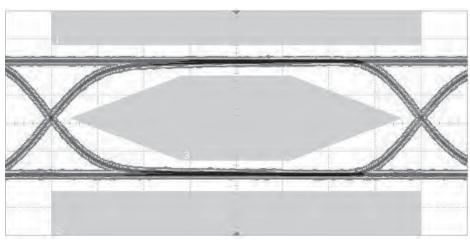


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Data rate: 480 Mbit/s (USB 2.0 High-speed)

Vertical scale = 200 mV/div Horizontal scale = 260 ps/div

Fig 7. USB 2.0 eye diagram with IP4369CX4



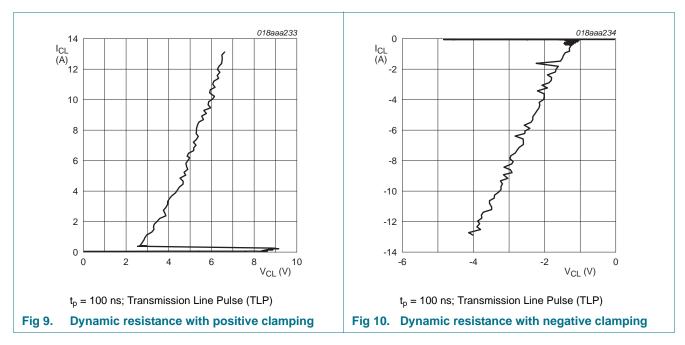
018aaa232

Data rate: 480 Mbit/s (USB 2.0 High-speed)

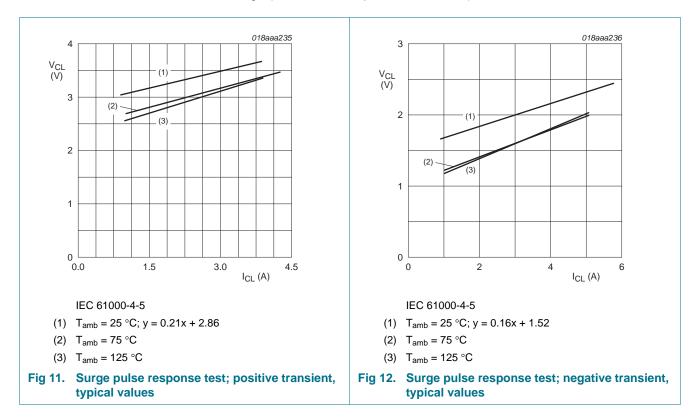
Vertical scale = 200 mV/div Horizontal scale = 260 ps/div

Fig 8. USB 2.0 eye diagram without IP4369CX4

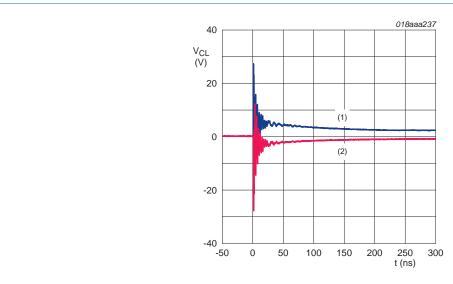
#### **ESD** protection for high-speed interfaces



The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).



## **ESD** protection for high-speed interfaces



- (1) +8 kV
- (2) -8 kV

Fig 13. ESD pulse transient response; IEC 61000-4-2; contact discharge; typical values

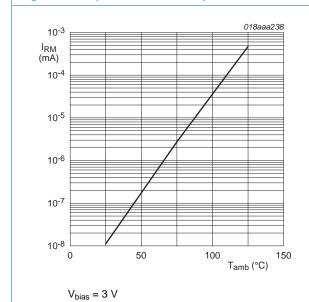


Fig 14. Reverse leakage current as a function of ambient temperature; typical values

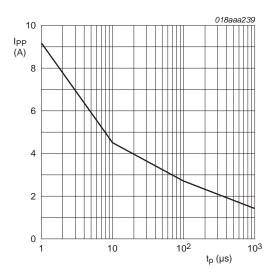


Fig 15. Peak pulse current as a function of pulse duration; rectangular pulses; typical values

## **ESD** protection for high-speed interfaces

# 6. Package outline

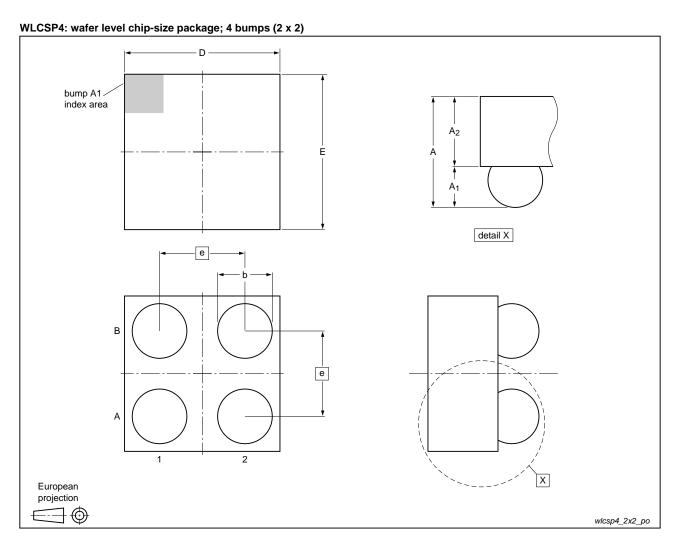


Fig 16. Package outline IP4369CX4 (WLCSP4)

Table 5. Package outline dimensions of IP4369CX4 (WLCSP4)

Symbol	Min	Тур	Max	Unit
A	0.44	0.47	0.50	mm
A <sub>1</sub>	0.18	0.20	0.22	mm
A <sub>2</sub>	0.26	0.27	0.28	mm
b	0.21	0.26	0.31	mm
D	0.71	0.76	0.81	mm
E	0.71	0.76	0.81	mm
е	0.35	0.40	0.45	mm

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# 7. Design and assembly recommendations

## 7.1 PCB design guidelines

For optimum performance, use a Non-Solder Mask Defined (NSMD), also known as a copper-defined design, incorporating laser-drilled micro-vias connecting the ground pads to a buried ground-plane layer. This results in the lowest possible ground inductance and provides the best high frequency and ESD performance. Refer to <a href="Table 6">Table 6</a> for the recommended Printed-Circuit Board (PCB) design parameters.

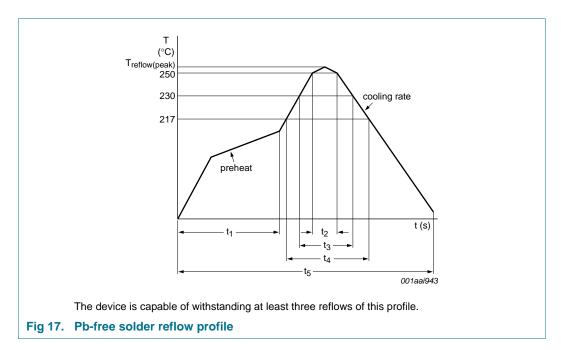
Table 6. Recommended PCB design parameters

Parameter	Value or specification
PCB pad diameter	250 μm
Micro-via diameter	100 μm (0.004 inch)
Solder mask aperture diameter	325 μm
Copper thickness	20 μm to 40 μm
Copper finish	AuNi
PCB material	FR4

## 7.2 PCB assembly guidelines for Pb-free soldering

Table 7. Assembly recommendations

Parameter	Value or specification
Solder screen aperture diameter	290 μm
Solder screen thickness	100 μm (0.004 inch)
Solder paste: Pb-free	SnAg (3 % to 4 %) Cu (0.5 % to 0.9 %)
Solder to flux ratio	50:50
Solder reflow profile	see Figure 17



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# ESD protection for high-speed interfaces

Table 8. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{reflow(peak)} \\$	peak reflow temperature		230	-	260	°C
t <sub>1</sub>	time 1	soak time	60	-	180	S
$t_2$	time 2	time during T $\geq$ 250 °C	-	-	30	S
$t_3$	time 3	time during T $\geq$ 230 $^{\circ}C$	10	-	50	S
t <sub>4</sub>	time 4	time during T > 217 $^{\circ}$ C	30	-	150	s
t <sub>5</sub>	time 5		-	-	540	S
dT/dt	rate of change of temperature	cooling rate	-	-	-6	°C/s
		pre-heat	2.5	-	4.0	°C/s

# ESD protection for high-speed interfaces

# 8. Revision history

## Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
IP4369CX4 v.1	20121001	Product data sheet	-	-

#### **ESD** protection for high-speed interfaces

# 9. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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